

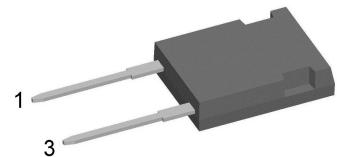
Schottky Diode

V_{RRM} = 600 V
 I_{FAV} = 17 A
 V_F = 2.54 V

High Performance Schottky Diode
 Low Loss and Soft Recovery
 Single Diode

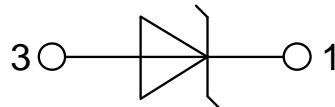
Part number

DSS17-06CR



Backside: isolated

E72873



Features / Advantages:

- Very low V_F
- Extremely low switching losses
- Low I_{rm} values
- Improved thermal behaviour
- High reliability circuit operation
- Low voltage peaks for reduced protection circuits
- Low noise switching

Applications:

- Rectifiers in switch mode power supplies (SMPS)
- Free wheeling diode in low voltage converters

Package: ISOPLUS247

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0
- Soldering pins for PCB mounting
- Backside: DCB ceramic
- Reduced weight
- Advanced power cycling

Terms & Conditions of usage:

The data contained in this product data sheet is exclusively intended for technically trained staff. The user will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to his application. The specifications of our components may not be considered as an assurance of component characteristics. The information in the valid application- and assembly notes must be considered. Should you require product information in excess of the data given in this product data sheet or which concerns the specific application of your product, please contact your local sales office.

Due to technical requirements our product may contain dangerous substances. For information on the types in question please contact your local sales office.

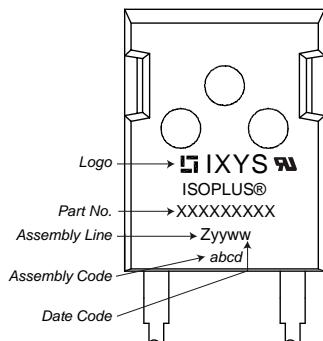
Should you intend to use the product in aviation, in health or life endangering or life support applications, please notify. For any such application we urgently recommend

- to perform joint risk and quality assessments;
- the conclusion of quality agreements;
- to establish joint measures of an ongoing product survey, and that we may make delivery dependent on the realization of any such measures.

Schottky			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
V_{RSM}	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			600	V
V_{RRM}	max. repetitive reverse blocking voltage	$T_{VJ} = 25^\circ C$			600	V
I_R	reverse current, drain current	$V_R = 600 V$ $V_R = 600 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		500 5	μA mA
V_F	forward voltage drop	$I_F = 15 A$ $I_F = 30 A$ $I_F = 15 A$ $I_F = 30 A$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		3.17 3.46 2.54 2.90	V V V V
I_{FAV}	average forward current	$T_C = 95^\circ C$ rectangular $d = 0.5$	$T_{VJ} = 175^\circ C$		17	A
V_{F0} r_F	threshold voltage slope resistance } for power loss calculation only		$T_{VJ} = 175^\circ C$		1.91 21.5	V $m\Omega$
R_{thJC}	thermal resistance junction to case				1.4	K/W
R_{thCH}	thermal resistance case to heatsink			0.25		K/W
P_{tot}	total power dissipation	$T_C = 25^\circ C$			105	W
I_{FSM}	max. forward surge current	$t = 10 \text{ ms}; (50 \text{ Hz}), \text{sine}; V_R = 0 V$	$T_{VJ} = 45^\circ C$		200	A
C_J	junction capacitance	$V_R = 400 V$ f = 1 MHz	$T_{VJ} = 25^\circ C$	20		pF

Package ISOPLUS247

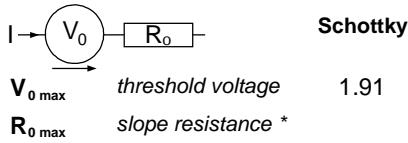
Symbol	Definition	Conditions			Ratings	
					min.	typ.
I_{RMS}	<i>RMS current</i>	per terminal			50	A
T_{VJ}	<i>virtual junction temperature</i>		-55		175	°C
T_{op}	<i>operation temperature</i>		-55		150	°C
T_{stg}	<i>storage temperature</i>		-55		150	°C
Weight				6		g
F_c	<i>mounting force with clip</i>		20		120	N
$d_{Spp/App}$	<i>creepage distance on surface striking distance through air</i>			<i>terminal to terminal</i>	5.4	mm
$d_{Spb/Apb}$				<i>terminal to backside</i>	4.1	mm
V_{ISOL}	<i>isolation voltage</i>	$t = 1 \text{ second}$ $t = 1 \text{ minute}$	50/60 Hz, RMS; $I_{ISOL} \leq 1 \text{ mA}$		3600 3000	V V

Product Marking

Ordering	Ordering Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	DSS17-06CR	DSS17-06CR	Tube	30	480266

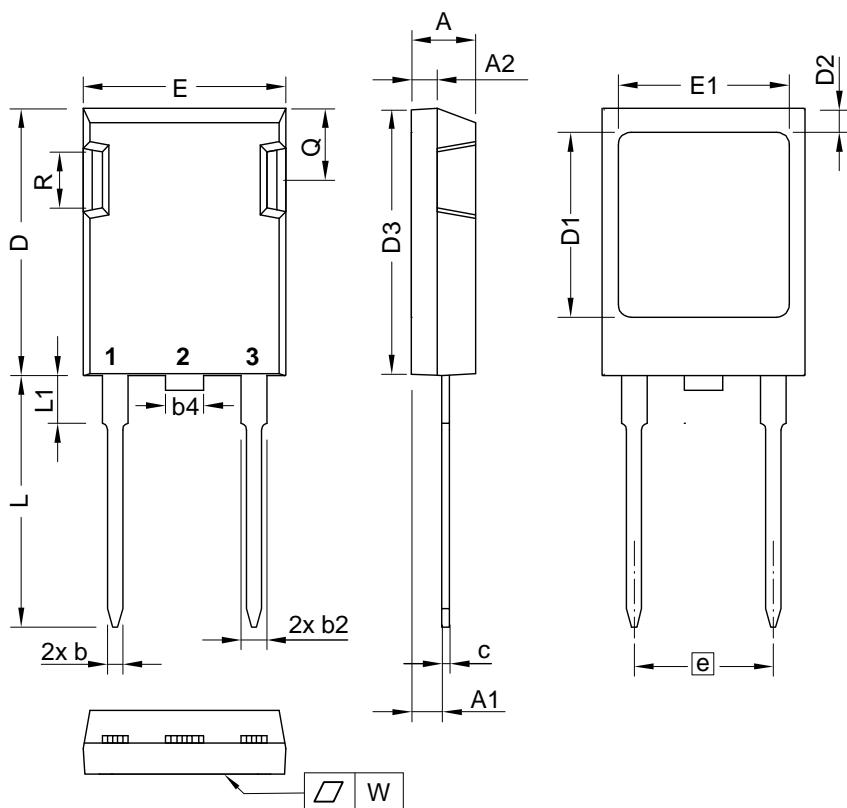
Equivalent Circuits for Simulation

* on die level

 $T_{VJ} = 175 \text{ °C}$ 

$V_{0\max}$ threshold voltage 1.91 V
 $R_{0\max}$ slope resistance * mΩ

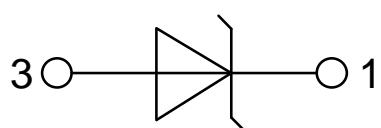
Outlines ISOPLUS247



Dim.	Millimeter		Inches	
	min	max	min	max
A	4.83	5.21	0.190	0.205
A1	2.29	2.54	0.090	0.100
A2	1.91	2.16	0.075	0.085
b	1.14	1.40	0.045	0.055
b2	1.91	2.20	0.075	0.087
b4	2.92	3.24	0.115	0.128
c	0.61	0.83	0.024	0.033
D	20.80	21.34	0.819	0.840
D1	15.75	16.26	0.620	0.640
D2	1.65	2.15	0.065	0.085
D3	20.30	20.70	0.799	0.815
E	15.75	16.13	0.620	0.635
E1	13.21	13.72	0.520	0.540
e	10.90	BSC	0.429	BSC
L	19.81	20.60	0.780	0.811
L1	3.81	4.38	0.150	0.172
Q	5.59	6.20	0.220	0.244
R	4.25	5.50	0.167	0.217
W	-	0.10	-	0.004

Die konvexe Form des Substrates ist typ. < 0.04 mm über der Kunststoffoberfläche der Bauteilunterseite
The convex bow of substrate is typ. < 0.04 mm over plastic surface level of device bottom side

Die Gehäuseabmessungen entsprechen dem Typ TO-247 AD gemäß JEDEC außer Schraubloch und L_{max} .
This drawing will meet all dimensions requirement of JEDEC outline TO-247 AD except screw hole and except L_{max} .



Schottky

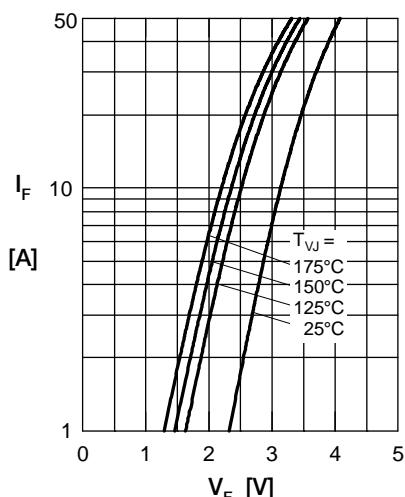


Fig. 1 Max. forward voltage drop characteristics

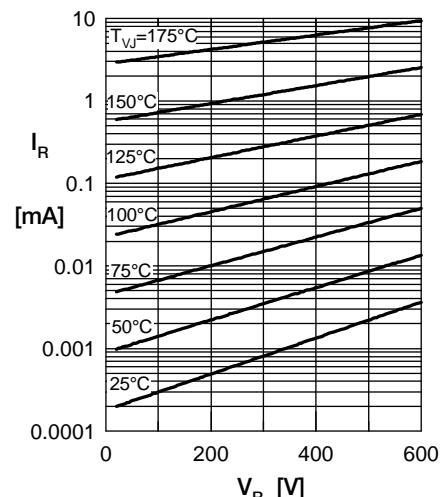
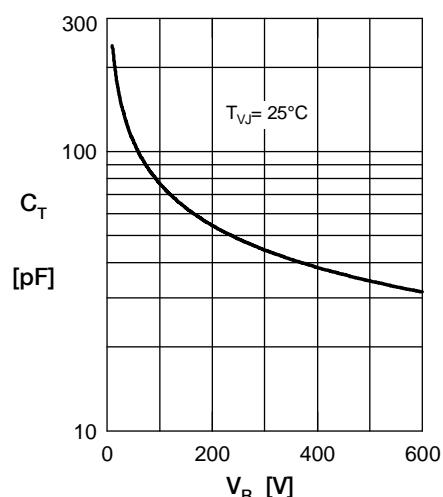
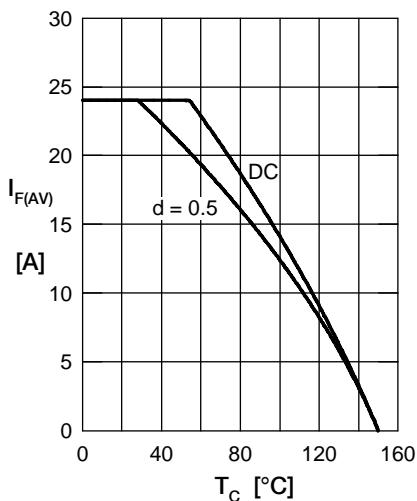
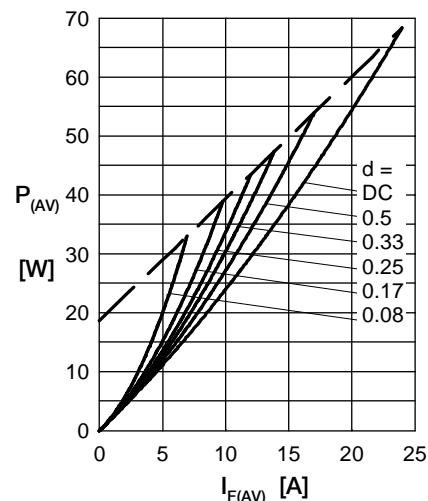
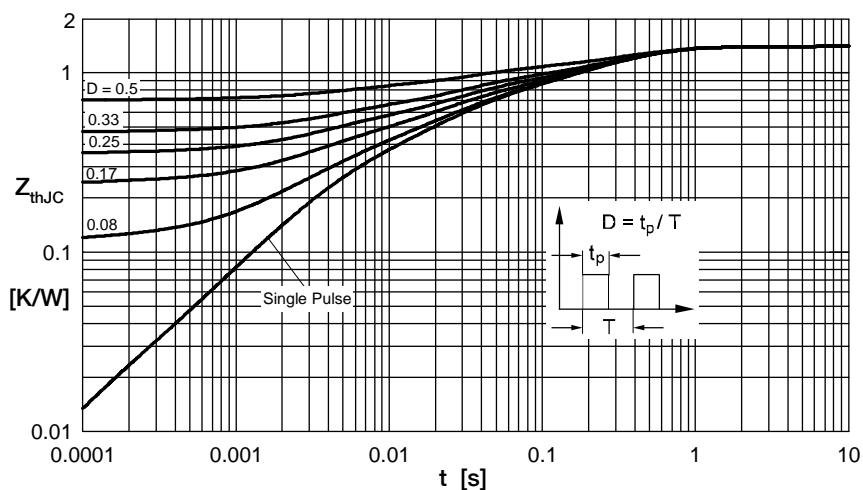
Fig. 2 Typ. reverse current I_R vs. reverse voltage V_R Fig. 3 Typ. junction capacitance C_T vs. reverse voltage V_R Fig. 4 Average forward current $I_{F(AV)}$ vs. case temp. T_C 

Fig. 5 Forward power loss characteristics



Note: All curves are per diode

Fig. 6 Transient thermal impedance junction to case at various duty cycles